

# Single N-channel MOSFET

## ELM14412AA-N

### ■ General description

ELM14412AA-N uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate resistance.

### ■ Features

- $V_{ds}=30V$
- $I_d=8.5A$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 26m\Omega$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 34m\Omega$  ( $V_{gs}=4.5V$ )

### ■ Maximum absolute ratings

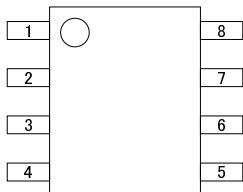
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	30	V	
Gate-source voltage	$V_{gs}$	$\pm 12$	V	
Continuous drain current	$I_d$	8.5	A	1
		7.1		
Pulsed drain current	$I_{dm}$	60	A	2
Power dissipation	$P_d$	3.0	W	
		2.1		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	31	40	°C/W	1
Maximum junction-to-ambient	Steady-state		59	75	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	16	24	°C/W	3

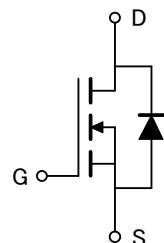
### ■ Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

### ■ Circuit



# Single N-channel MOSFET

## ELM14412AA-N

### ■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>							
Drain-source breakdown voltage	BVdss	$I_d=250\mu A$ , $V_{gs}=0V$		30			V
Zero gate voltage drain current	Idss	$V_{ds}=24V$				1	$\mu A$
		$V_{gs}=0V$	$T_j=55^\circ C$			5	
Gate-body leakage current	Igss	$V_{ds}=0V$ , $V_{gs}=\pm 12V$				100	nA
Gate threshold voltage	Vgs(th)	$V_{ds}=V_{gs}$ , $I_d=250\mu A$		1.0	1.8	3.0	V
On state drain current	$I_d(on)$	$V_{gs}=4.5V$ , $V_{ds}=5V$		30			A
Static drain-source on-resistance	Rds(on)	$V_{gs}=10V$			22	26	$m\Omega$
		$I_d=8.5A$	$T_j=125^\circ C$				
		$V_{gs}=4.5V$ , $I_d=5A$			28	34	
Forward transconductance	Gfs	$V_{ds}=5V$ , $I_d=5A$					S
Diode forward voltage	Vsd	$I_s=1A$ , $V_{gs}=0V$			0.76	1.00	V
Max. body-diode continuous current	Is					4	A
<b>DYNAMIC PARAMETERS</b>							
Input capacitance	Ciss	$V_{gs}=0V$ , $V_{ds}=15V$ , $f=1MHz$			590		pF
Output capacitance	Coss				162		pF
Reverse transfer capacitance	Crss				40		pF
Gate resistance	Rg	$V_{gs}=0V$ , $V_{ds}=0V$ , $f=1MHz$			0.45		$\Omega$
<b>SWITCHING PARAMETERS</b>							
Total gate charge	Qg	$V_{gs}=4.5V$ , $V_{ds}=15V$ , $I_d=8.5A$			6.04		nC
Gate-source charge	Qgs				1.46		nC
Gate-drain charge	Qgd				2.56		nC
Turn-on delay time	td(on)	$V_{gs}=10V$ , $V_{ds}=15V$ $R_l=1.8\Omega$ , $R_{gen}=3\Omega$			3.7		ns
Turn-on rise time	tr				3.5		ns
Turn-off delay time	td(off)				14.9		ns
Turn-off fall time	tf				2.5		ns
Body diode reverse recovery time	trr	$I_f=5A$ , $dl/dt=100A/\mu s$					ns
Body diode reverse recovery charge	Qrr	$I_f=5A$ , $dl/dt=100A/\mu s$					nC

### NOTE :

1. The value of  $R_{\theta ja}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with  $T_a=25^\circ C$ . The value in any given applications depends on the user's specific board design, The current rating is based on the  $t \leq 10s$  thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The  $R_{\theta ja}$  is the sum of the thermal impedance from junction to lead  $R_{\theta jl}$  and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 $\mu s$  pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ C$ . The SOA curve provides a single pulse rating.

# Single N-channel MOSFET

**ELM14412AA-N**

## ■ Typical electrical and thermal characteristics

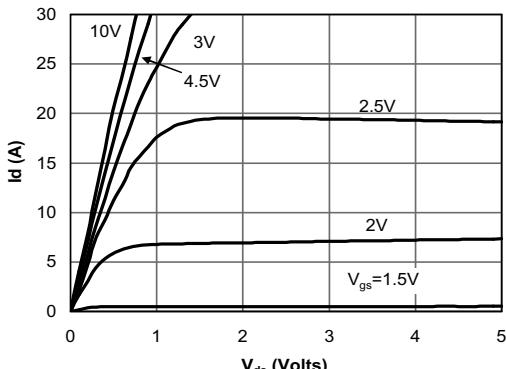


Fig 1: On-Region Characteristics

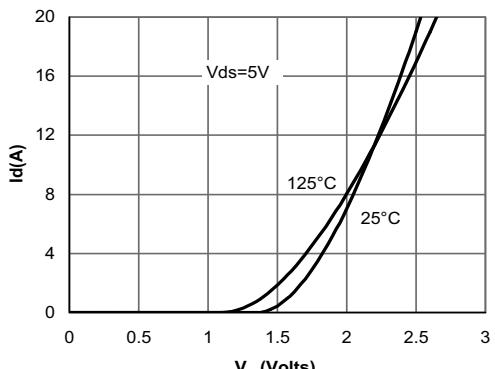


Figure 2: Transfer Characteristics

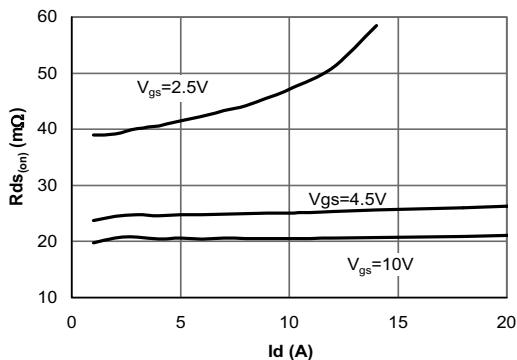


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

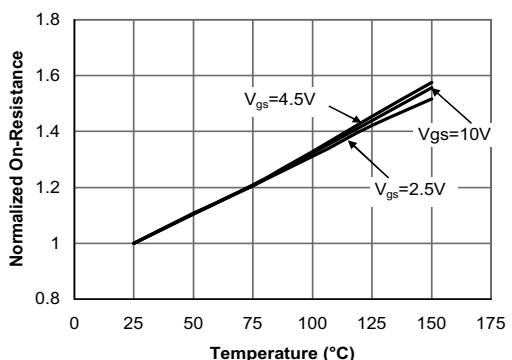


Figure 4: On-Resistance vs. Junction Temperature

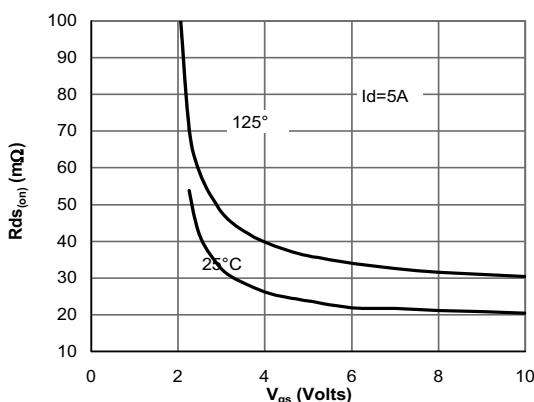


Figure 5: On-Resistance vs. Gate-Source Voltage

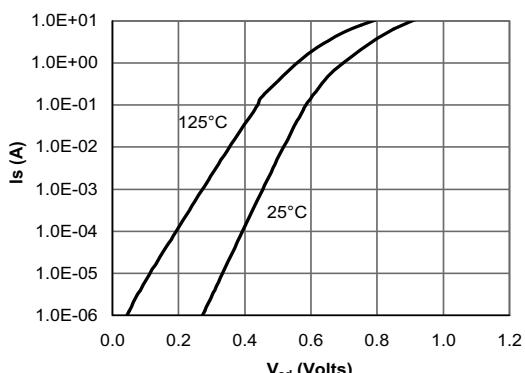


Figure 6: Body-Diode Characteristics

# Single N-channel MOSFET

ELM14412AA-N

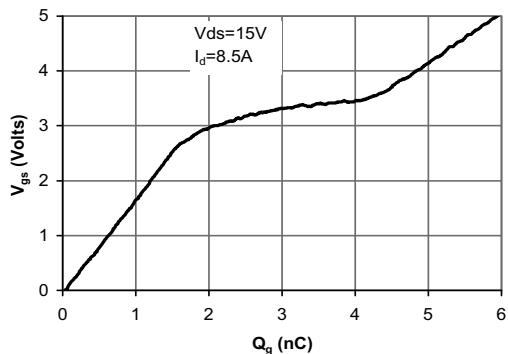


Figure 7: Gate-Charge Characteristics

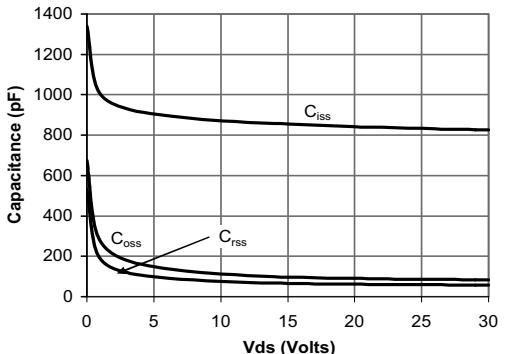


Figure 8: Capacitance Characteristics

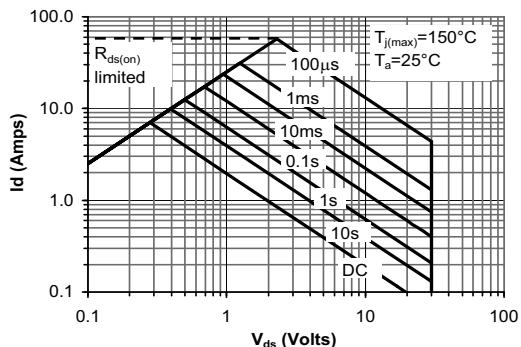


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

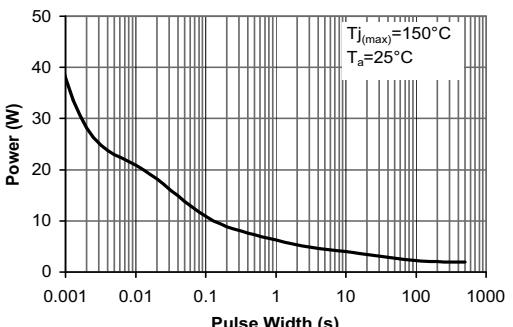


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

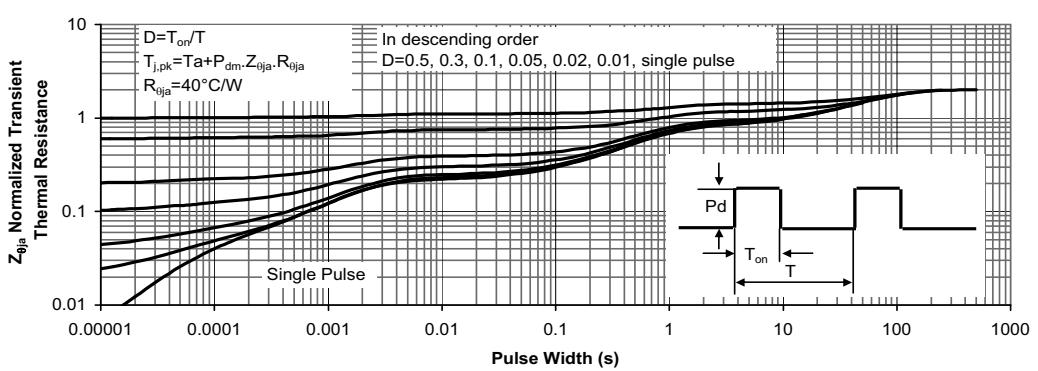


Figure 11: Normalized Maximum Transient Thermal Impedance